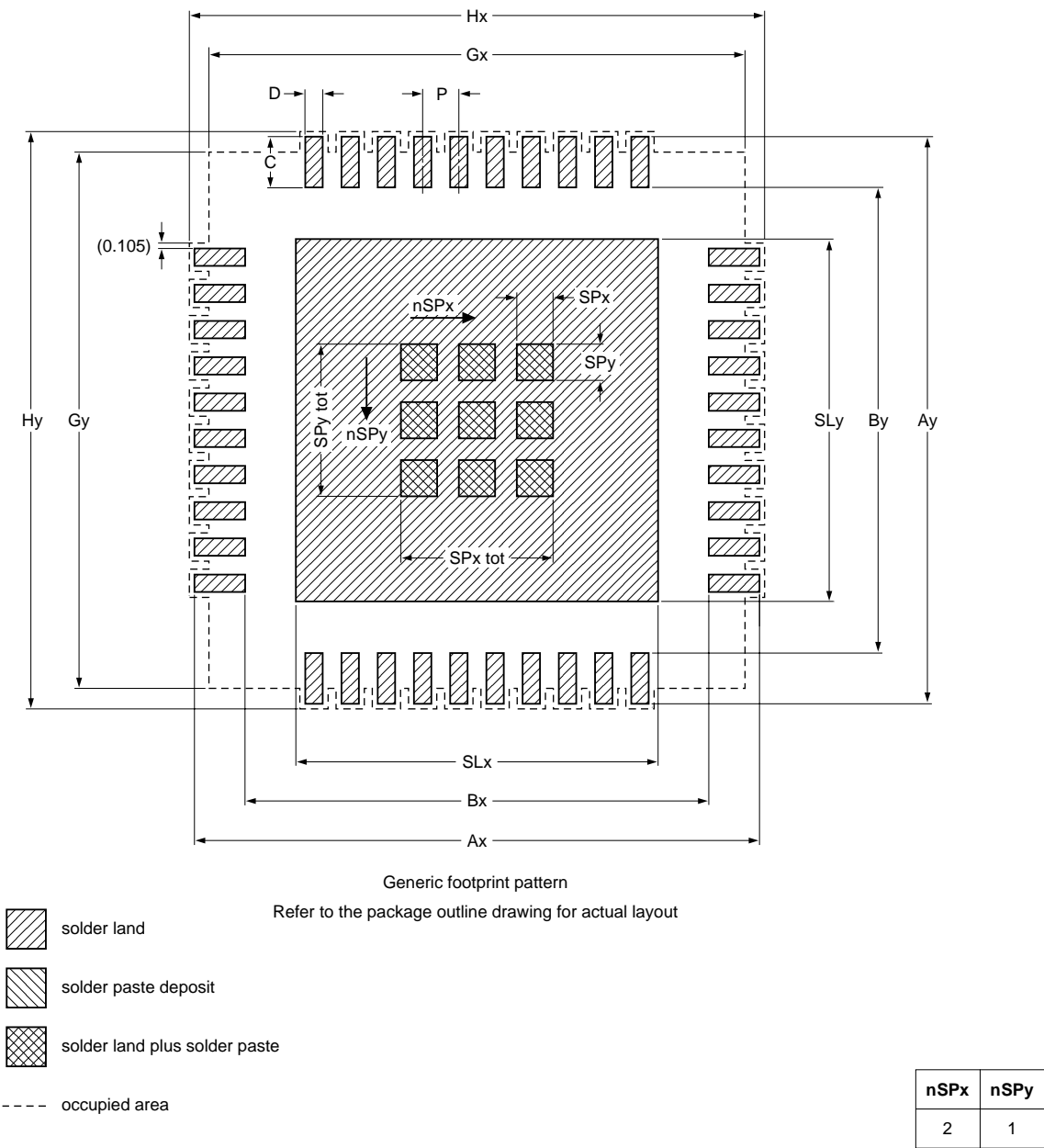


Footprint information for reflow soldering of DHVQFN16 package

SOT763-1



DIMENSIONS in mm																
P	Ax	Ay	Bx	By	C	D	SLx	SLy	SPx tot	SPy tot	SPx	SPy	Gx	Gy	Hx	Hy
0.500	4.500	3.500	2.700	1.700	0.900	0.240	1.900	0.900	1.100	0.400	0.400	0.400	3.800	2.800	4.750	3.750